Docket No.: 51876P375

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re the Application of:

JEONG-HO BANG, ET AL.

Application No.:

Filed:

For: Pipe Latch Circuit For Outputting Data

With High Speed

Art Group:

Examiner:

#### INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. §1.97

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In accordance with the duty of disclosure, enclosed is a copy of Information Disclosure Statement by Applicant (form PTO/SB/08), which is being submitted concurrently with the Utility Application. It is respectfully requested that the cited references be considered and that the enclosed copy of PTO/SB/08 be initialed by the Examiner to indicate such consideration and a copy thereof returned to applicant(s).

The submission of this Information Disclosure Statement is not to be construed as a representation that a search has been made in the subject application and is not to be construed as an admission that the information cited in this statement is material to patentability.

Please charge any fees due to Deposit Account 02-2666. A duplicate copy of the Fee Transmittal (PTO/SB/17) is enclosed for this purpose.

Respectfully submitted,

BLAKELY, SOKOLOFF, TAYLOR & ZAFMAN LLP

Eric S. Hyman, Reg. No. 30,139

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# INFORMATION DISCLOSURE STATEMENT BY APPLICANT

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Complete if Known					
Application Number					
Filing Date	· .				
First Named Inventor	Jeong-Ho Bang				
Art Unit					
Examiner Name					
Attorney Docket Number	51876P375				

	U.S. PATENT DOCUMENTS							
Examiner Initials*	Cite No.1	Document Number  Number - Kind Code <sup>2</sup> (if known)	Publication Date or Issue Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear			
		US-6564287	05-13-2003	Lee				
		US-6552955	04-22-2003	Miki				
		US-6392909	05-21-2002	Jang et al.				
		US-6353574	03-05-2002	Shim				
		US-6262938	07-17-2001	Lee et al.				
		US-5892730	04-06-1999	Sato et al.				
		US-2003/0081491	05-01-2003	Miki				
		US-2002/0074961	06-20-2002	Ziegenhorn et al.				
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FOREIGN PATENT DOCUMENTS							
Examiner Cite	Cite	Foreign Patent Document			Pages, Columns, Lines,	T	
Initials* No.1		Country Code <sup>3</sup> - Number <sup>4</sup> - Kind Code <sup>5</sup> (if known)	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Where Relevant Passages or Relevant Figures Appear	T <sup>e</sup>	
		2002-133866	05-10-2002	Samsung Electronics Co. Ltd.		7	
		2001-035155	02-09-2001	Hyundai Electronics Ind. Co. Ltd.			
		2000-276877	10-06-2000	Samsung Electronics Co Ltd.			
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- 7							

Examiner		Date			
Signature		Considered			1

\*Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication.

<sup>1</sup>Applicant's unique citation designation number (optional). <sup>2</sup>See Kinds Codes of USPTO Patent Documents at www.uspto.gov or MPEP 901.04. <sup>3</sup>Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). <sup>4</sup>For Japanese patent documents, the indication of the year of reign of the Emperor must precede the serial number of the patent document. <sup>5</sup>Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. <sup>6</sup>Applicant is to place a check mark here if English language Translation is attached.

Based on PTO/SB/08A (05-03) as modified by Blakely, Solokoff, Taylor & Zafman (wlr) 05/02/2003.

# **Information Disclosure Statement**

# New U.S. Patent Application for PIPE LATCH CIRCUIT FOR OUTPUTTING DATA WITH HIGH SPEED

Our Ref. No.: P02H6021/US/wy

### Reference No.:

- (1) US Patent No. 6,564,287
- (2) US Patent No. 6,552,955
- (3) US Patent No. 6,392,909
- (4) US Patent No. 6,353,574
- (5) US Patent No. 6,262,938
- (6) US Patent No. 5,892,730
- (7) US Publication No. 2003/0081491 A1
- (8) US Publication No. 2002/0074961 A1
- (9) JP Laid-Open No. 2002-133866
- (10) JP Laid-Open No. 2001-35155
- (11) JP Laid-Open No. 2000-276877